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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/722,814	11/26/2003	Cha Deok Dong	29936/39765	9355		
4743	7590 05/18/2006		EXAMINER			
MARSHALL, GERSTEIN & BORUN LLP			DEO, DUY VU NGUYEN			
233 S. WACK SEARS TOWI	ER DRIVE, SUITE 630 ER	ART UNIT	PAPER NUMBER			
CHICAGO, IL 60606			1765			
			DATE MAILED: 05/18/200	6		

Please find below and/or attached an Office communication concerning this application or proceeding.

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		Application	1 140.		Applicant(s)	
Office Assistant Commencer		10/722,814	ł	DONG ET AL.		
	Office Action Summary	LXammer		Art Unit		
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Period f	The MAILING DATE of this com or Reply	munication appears on the o	cover sheet with the	e correspondence	e address	
WHIO - Extending - Extending - If No - Faile Any	HORTENED STATUTORY PERIOR CHEVER IS LONGER, FROM THE PRISONS of time may be available under the proving SIX (6) MONTHS from the mailing date of this Depriod for reply is specified above, the maximure to reply within the set or extended period for reply received by the Office later than three mooted patent term adjustment. See 37 CFR 1.704	E MAILING DATE OF THIS sions of 37 CFR 1.136(a). In no even communication. um statutory period will apply and will or reply will, by statute, cause the applicanths after the mailing date of this communication.	S COMMUNICATI tt, however, may a reply be expire SIX (6) MONTHS frecation to become ABANDO	ON. e timely filed rom the mailing date of to NED (35 U.S.C. § 133)	his communication.	
Status	•	,				
1\\∏	Responsive to communication(s) filed on 21 March 2006				
	This action is FINAL .	2b)⊠ This action is no	n-final			
	Since this application is in condi	/—		prosecution as to	the merits is	
,	closed in accordance with the pr	•	•		.2.3	
Disposit	ion of Claims					
5)□ 6)⊠ 7)□	Claim(s) 1-3 and 5-9 is/are pend 4a) Of the above claim(s) Claim(s) is/are allowed. Claim(s) 1-3, 5-9 is/are rejected. Claim(s) is/are objected to Claim(s) are subject to re	is/are withdrawn from cons				
Applicat	ion Papers					
9)[The specification is objected to b	y the Examiner.				
10)[The drawing(s) filed on is/	are: a) accepted or b) □	objected to by th	e Examiner.		
	Applicant may not request that any	objection to the drawing(s) be	held in abeyance.	See 37 CFR 1.85(a	ı).	
_	Replacement drawing sheet(s) inclu	-	- , ,	•	` '	
11)	The oath or declaration is objected	ed to by the Examiner. Note	e the attached Offi	ce Action or form	PTO-152.	
Priority (under 35 U.S.C. § 119					
а)	Acknowledgment is made of a cla All b) Some * c) None control 1. Certified copies of the price 2. Certified copies of the price 3. Copies of the certified copies of the lntern See the attached detailed Office a	of: writy documents have been writy documents have been ies of the priority documentational Bureau (PCT Rule	received. received in Applicate have been rece 17.2(a)).	ation No ived in this Natio	nal Stage	
Attachmer	, ,		_			
	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Revie	4 (DTO 048)	1) Interview Summa Paper No(s)/Mail			
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Art Unit: 1765

DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-5, 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Change et al. (US 6,380,029) and Dong et al. (US 2002/0068398).

At this time, the term "sequentially" will be interpreted as one after the other, but not necessarily to be in any order. Therefore, the polysilicon and metal silicide can be in any order.

Chang describes a method for forming a gate electrode comprising: forming a WSi 50 under a polysilicon 52 (claimed polysilicon film) on a substrate (col. 7, line 56-60; col. 8, line 21-22) (this would read on claimed sequentially); performing an RTA on the WSi at 900 degrees Celsius for about 20 s in a nitrogen atmosphere (col. 7, line 65-col. 8, line 2) (this would crystallize the WSi); forming a gate electrode by etching the WSi and the polysilicon using the same etching gas of Cl2/O2 to form a gate electrode (col. 8, line 53-55). Unlike claimed invention, Chang is silent about the physical characteristic of the WSi, which is its stochiometric ratio of (SiH2 or SiH2Cl2):WF6 of 2.0 to 2.8. Dong teaches a method for forming WSi wherein he teaches forming the WSi at a stochiometric ratio of (SiH2 or SiH2Cl2):WF6 of 2.3 to 2.8 (paragraph [0019]). At the time of the invention, one skilled in the art would find it obvious to form the WSi in further review of Dong's method because Dong teaches another necessary

characteristic of the WSi that would facilitate the depositing of the WSi with a reasonable expectation of success.

Referring to claim 8, the RTA would results in the etch rate of the crystallized WSi being similar to that of the polysilicon film because the same process and processing parameters are being performed on the WSi.

3. Claims 6 and 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chang and Dong as applied to claim 1 above, and further in view of Xu et al. (US 6,544,896).

Referring to claims 6 and 7, even though Chang doesn't describe the etching process is performed in an inductively couple plasma chamber. However, using any plasma chamber that is known to one skilled in the art, such as an inductively couple plasma chamber as shown here by Xu (col. 1, line 30-35; col. 4, line 20-37), at the time of the invention would be obvious in order to provide plasma for the etching of the WSi and polysilicon with a reasonable expectation of success.

Response to Arguments

4. In response to applicant's argument that the references fail to show certain features of applicant's invention, it is noted that the features upon which applicant relies (i.e., the polysilicon 52 is formed as a control gate) are not recited in the rejected claim(s). Although the claims are interpreted in light of the specification, limitations from the specification are not read into the claims. See *In re Van Geuns*, 988 F.2d 1181, 26 USPQ2d 1057 (Fed. Cir. 1993). The polysilicon 52 described by Chang is a part of the gate electrode; therefore, it would read on

claimed polysilicon film and etching the WSi and polysilicon film to form a gate electrode comprising WSi and the polysilicon film.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DuyVu n. Deo whose telephone number is 571-272-1462. The examiner can normally be reached on 6 am -2:30 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Primary Examiner Duy-Vu N Deo 5/15/06